

#### Quad 2-Input AND Gate in bare die form

Rev 1.1 23/01/24

#### Description

The 74ALS08 quad 2-input AND gate is fabricated using using a 2µm 40V Bipolar process. The device consists of four independent 2-input AND gates with standard push-pull outputs and performs the Boolean function  $Y = A \cdot B$  or  $Y = \overline{A} + \overline{B}$ . All inputs are protected against ESD and excess voltage transients.

#### Features:

- High speed 4ns (Min) propagation data
- Direct drop-in replacement for o soleto components in long term programs.

#

#### **Ordering Information**

The following part suffixes apply:

No suffix - MIL-STD-883 /2010B Visual Inspection

For High Reliability versions of this product please see

54ALS08

#### Die Dimensions in µm (mils)

<b>←</b>	1600 (63)	
		1100 (43)

#### Supply Formats:

- Defaut Die in Waffle Pack (300 per tray capacity)
- Sawn Wafer on Tape On request
- Unsawn Wafer On request
- Die Thickness <> 350µm(14 Mils) On request
- Assembled into Ceramic Package On request

#### **Mechanical Specification**

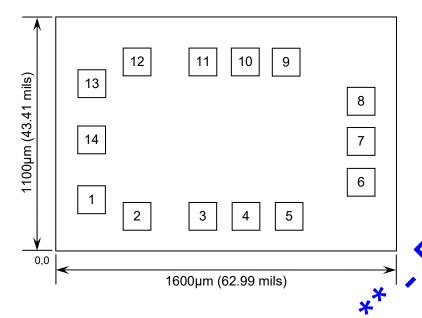
Die Size (Unsawn)	1600 x 1100 63 x 43	µm mils	
Minimum Bond Pad Size	130 x 130 5.12 x 5.12	µm mils	
Die Thickness	350 (±20) 13.78 (±0.79)	μm mils	
Top Metal Composition	Al 1%Si 1.1μm		
Back Metal Composition	N/A – Bare S	Si	





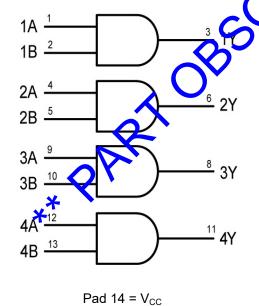
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#### Pad Layout and Functions



		COORDINATES (mm)				
PAD	FUNCTION	Х	Y			
1	1A	0.100	0.180			
2	1B	0.315	0.100			
3	1Y	0.625	0.100			
4	2	0.825	0.100			
5	2B	1.025	0.100			
6	21	1.370	0.260			
70	GND	1.370	0.450			
8	3Y	1.370	0.640			
	3A	1.015	0.825			
10	3B	0.825	0.825			
11	4Y	0.625	0.825			
12	4A	0.425	0.825			
13	4B	0.100	0.725			
14	V <sub>CC</sub>	0.100	0.460			
CONNECT CHIP BACK TO GND						

#### Logic Diagram



#### **Function Table**

INP	UTS	OUTPUT			
Α	В	Υ			
L	L	L			
L	Н	L			
Н	L	L			
Н	Н	Н			
H - High level (steady state)					

H = High level (steady state)

L = Low level (steady state)

Pad 7 = GND



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#### Absolute Maximum Ratings<sup>1</sup>

PARAMETER	SYMBOL	VALUE	UNIT
DC Supply Voltage	V <sub>CC</sub>	7.0	V
DC Input Voltage	V <sub>IN</sub>	7.0	<b>X</b>
Storage Temperature Range	T <sub>STG</sub>	-65 to 150	~

<sup>1.</sup> Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for expanded periods, may reduce device reliability.

#### **Recommended Operating Conditions**

PARAMETER	SYMBOL	MIN	MAX	UNITS
Supply Voltage	V <sub>CC</sub>	4.5	5.5	V
High-Level Input Voltage	$V_{IH}$	2	-	V
Low-Level Input Voltage	$V_{IL}$	-	8.)	V
High-Level Output Current	I <sub>OH</sub>	-	0.4	mA
Low-Level Output Current	I <sub>OL</sub>	-	8	mA
Operating Temperature Range	$T_J$	-40	+55	°C

# DC Electrical Characteristics<sup>2</sup> T<sub>J</sub> = -40°C to 85°C unless otherwise specified

PARAMETER	SYMBOL	COADI	CONDITIONS		LIMITS		
TANAMETER	STIMBOL		JIIO	MIN	TYP	MAX	UNITS
Minimum High-Level Input Voltage	V <sub>IH</sub>			2	-	-	V
Maximum Low-Level Input Voltage	V <sub>IL</sub>	<u> </u>		-	-	0.8	V
Input Clamp Diode Voltage	NO.	$V_{CC} = MIN$ $I_{IN} = -18mA$		-	-	-1.5	V
Output Voltage High	₩ <sub>H</sub>	$V_{CC} = 4.5V \text{ to } 5.5V,$ $I_{OH} = -0.4\text{mA}$		V <sub>CC</sub> -2	-	-	V
Output Voltage Cov	V <sub>OL</sub> V <sub>CC</sub>	V <sub>CC</sub> = 4.5V	$I_{OL} = 4mA$	-	0.25	0.4	V
Output Voltage Lov		VCC - 4.5V	I <sub>OL</sub> = 8mA	-	0.35	0.5	Į v
Input Current	I <sub>IN</sub>	$V_{CC} = 5.5V, V_{IN} = 7V$		-	-	0.1	mA
Input High Current	I <sub>IH</sub>	$V_{CC} = 5.5V, V_{IN} = 2.7V$		-	-	20	μA
Input Low Current	I <sub>IL</sub>	$V_{CC} = 5.5, V_{IN} = 0.4V$		-	-	-0.1	mA
Output Current <sup>3</sup>	Io	$V_{CC} = 5.5, V_{OUT} = 2.25V$		-30	-	-112	mA
Power Supply	I <sub>CCH</sub>	$V_{CC} = 5.5V$ , V	V <sub>IN</sub> = 4.5V	-	1.3	2.4	mA
Current (Total)	I <sub>CCL</sub>	$V_{CC} = 5.5V$ ,	V <sub>IN</sub> = 0V	-	2.2	4	

**<sup>2</sup>**. All typical values @  $V_{CC} = 5V$ ,  $T_J = 25$ °C.

<sup>3.</sup> Output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, Ios



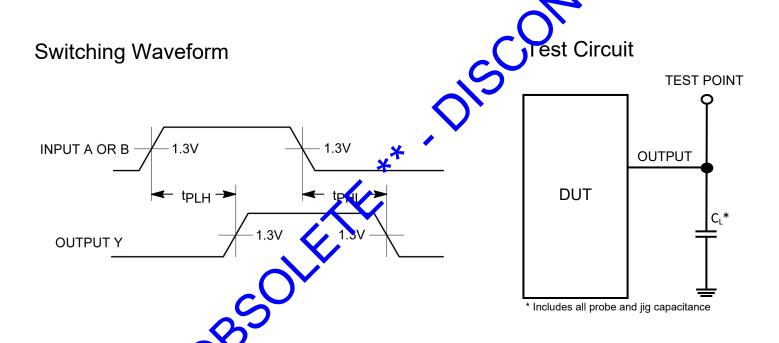


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### AC Electrical Characteristics T<sub>J</sub> = -40°C to 85°C unless otherwise specified

PARAMETER	SYMBOL	CONDITIONS	LIMITS			ONITS
1700 time 1 Erc			MIN	TYP	MAX	
Propagation Delay,	t <sub>PLH</sub>	$V_{CC} = 4.5 \text{ to } 5.5 \text{V},$	4	-	14	ns
A or B to output Y	t <sub>PHL</sub>	$C_L = 50 pF, R_L = 500 \Omega$	3	-	10	113

4. Not production tested in die form, characterized by chip design and tested in package.



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